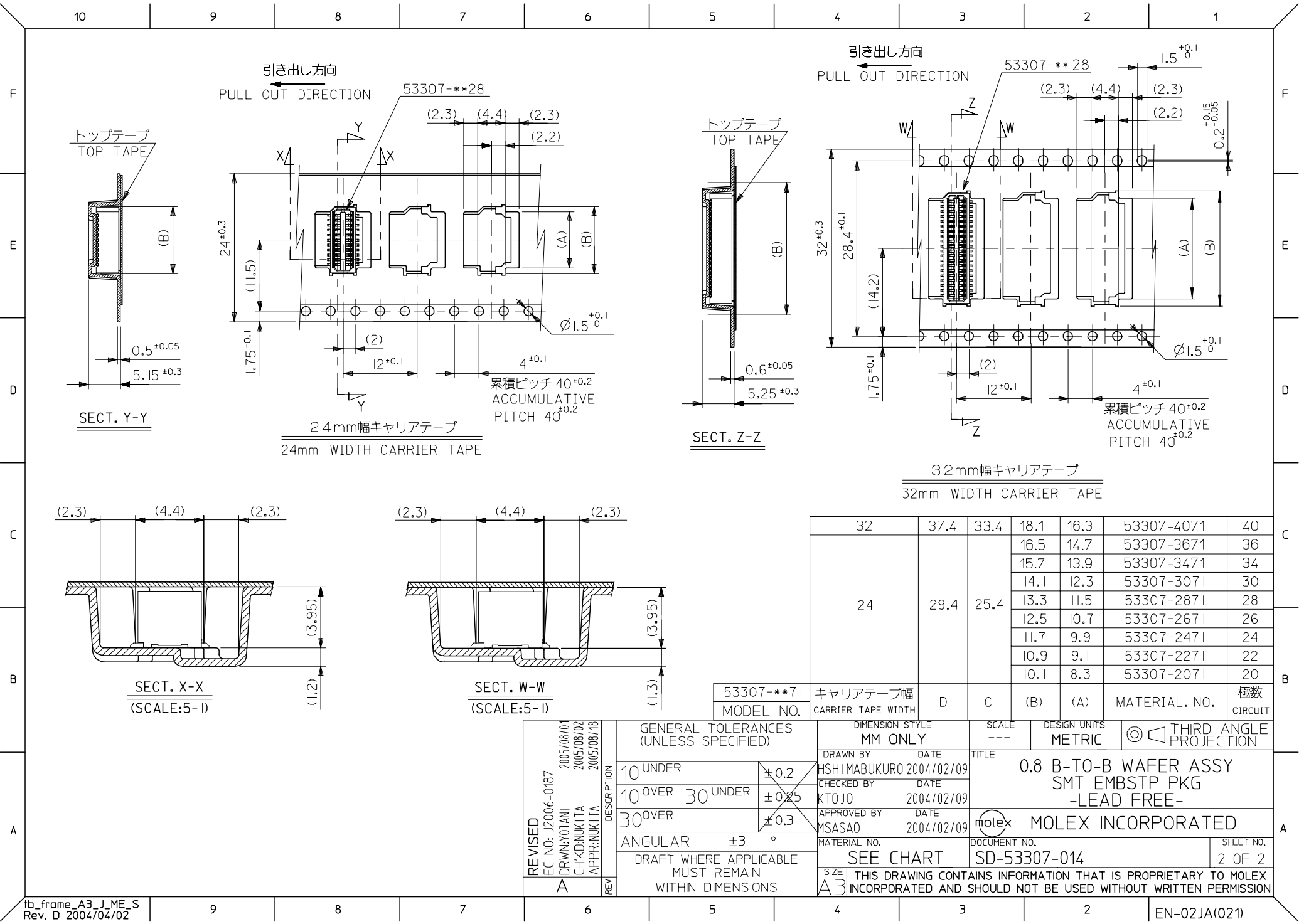
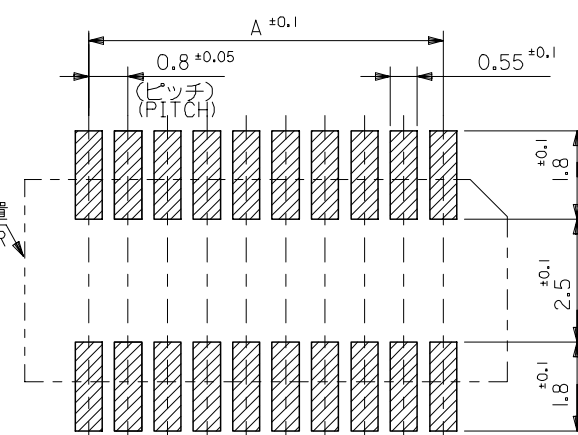


EN-02JA(021)

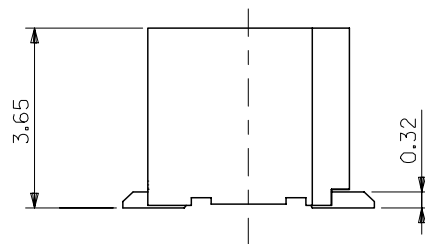




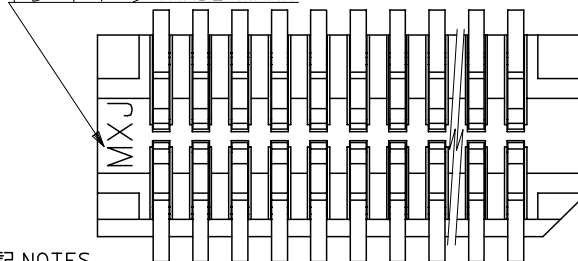
参考基板レイアウト（マウント面）

P.C.B. PATTERN LAYOUT (REF.) (MOUNT AREA)

0.4	17.8	16.9	15.2	53307-4028	40
0.8	17.0	16.1	14.4	-3828	38
0.4	16.2	15.3	13.6	-3628	36
0.8	15.4	14.5	12.8	-3428	34
0.4	14.6	13.7	12.0	-3228	32
0.8	13.8	12.9	11.2	-3028	30
0.4	13.0	12.1	10.4	-2828	28
0.8	12.2	11.3	9.6	-2628	26
0.4	11.4	10.5	8.8	-2428	24
0.8	10.6	9.7	8.0	-2228	22
0.4	9.8	8.9	7.2	-2028	20
0.8	9.0	8.1	6.4	-1828	18
0.4	8.2	7.3	5.6	-1628	16
0.8	7.4	6.5	4.8	-1428	14
0.4	6.6	5.7	4.0	-1228	12
0.8	5.8	4.9	3.2	53307-1028	10
D	C	B	A	MATERIAL. NO.	極数 CKT.



トレードマーク TRADE MARK



1. 嵌合相手: 52465,52588
MATE WITH : 52465,52588 SERIES

△ ウエハーの C から隣接するピンの C 迄の位置を示す。
SHOW POSITION FROM C OF WAFER TO C OF ADJACENT PINS.

3 本製品は 53307-**27 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 53307-**27

REVISED	EC NO: J2006-1257 DRAWN: YOTANI CHKD: NUKITA APPR: NUKITA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
			10 UNDER	± 0.2	DRAWN BY HSHI MABUKURO	DATE 2004/02/09	TITLE 0.8 B/B CONN WAFER ASSY ST SMT (SHEET 1 OF 2) -LEAD FREE-				
			10 OVER 30 UNDER	± 0.25	CHECKED BY KTOJO	DATE 2004/02/09					
			30 OVER	± 0.3	APPROVED BY MSASAO	DATE 2004/02/09	MOLEX INCORPORATED				
			ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-53307-015		1 OF 2		
REV	C		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

